

Title (en)  
Structure of metallic plates.

Title (de)  
Metallplättchenverbund.

Title (fr)  
Assemblage de plaques métalliques.

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Application  
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Abstract (en)  
[origin: CA2034133A1] The invention relates to a metal platelet compound comprising metal platelets disposed side by side and connected by linking members. This metal platelet compound is characterized by having applied to its underside, i.e. application side, a hot melt adhesive layer which increases the stability of the metal platelet compound and simplifies its handling.

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